Tianxiang Wu

List of Publications by Year in descending order

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2682572 2917675 4 8 2 2 citations h-index g-index papers 4 4 4 1 citing authors docs citations times ranked all docs

#	ARTICLE	IF	CITATIONS
1	Research on Flip-Chip Bonding Process and Thermal Cycle Reliability Simulation of 3-D Stacked Structure. IEEE Transactions on Components, Packaging and Manufacturing Technology, 2022, 12, 51-58.	2.5	6
2	Numerical Investigation on Granular Flow from a Wedgeâ€Shaped Feed Hopper Using the Discrete Element Method. Chemical Engineering and Technology, 2018, 41, 913-920.	1.5	2
3	Electromechanical Performance of Microprobe Test With Cuboid Magnetorheological Damper in Microelectronic Packaging. IEEE Transactions on Components, Packaging and Manufacturing Technology, 2022, 12, 723-730.	2.5	O
4	Research on the Mechanical Properties of Magnetorheological Damping and the Performance of Microprobe Test Process. Journal of Electronic Testing: Theory and Applications (JETTA), $0, 1$.	1.2	0